

2SJ248 Silicon P Channel MOS FET

REJ03G0855-0200 (Previous: ADE-208-1189) Rev.2.00 Sep 07, 2005

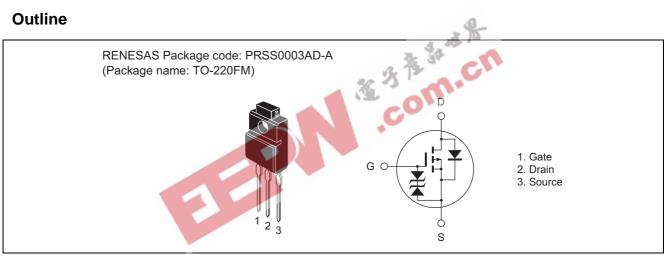
Description

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device can be driven from 5 V source
- Suitable for switching regulator, DC-DC converter

Outline





Absolute Maximum Ratings

			(Ta = 25°C)
ltem	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	-100	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	-8	A
Drain peak current	I _{D (pulse)} Note 1	-32	A
Body to drain diode reverse drain current	I _{DR}	-8	A
Channel dissipation	Pch Note 2	25	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 µs, duty cycle \leq 1%

2. Value at Tc = $25^{\circ}C$

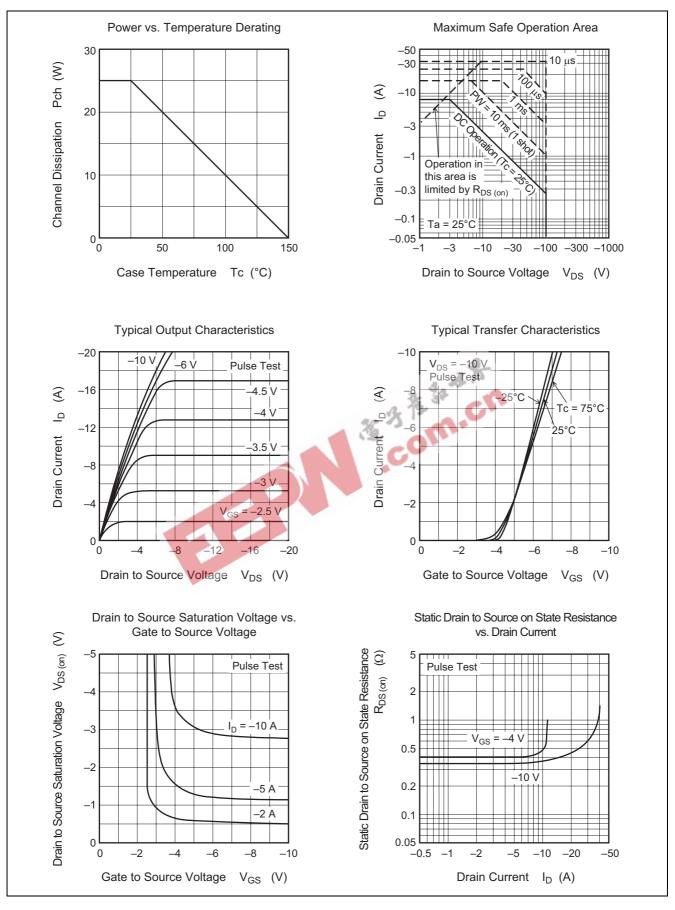
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	-100		—	V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±20	_	—	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	-		±10	μΑ	$V_{GS} = \pm 16 V, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	-		-250	μA	$V_{DS} = -80 \text{ V}, \text{ V}_{GS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	-1.0		-2.0	V	$I_{\rm D} = -1 \text{ mA}, V_{\rm DS} = -10 \text{ V}$
Static drain to source on state resistance	R _{DS (on)}		0.25	0.3	Ω	$I_{\rm D} = -4$ A, $V_{\rm GS} = -10$ V ^{Note 3}
	R _{DS (on)}		0.3	0.45	Ω	$I_D = -4 A, V_{GS} = -4 V^{Note 3}$
Forward transfer admittance	y _{fs}	3.0	5.5	0.	S	$I_D = -4 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note 3}}$
Input capacitance	Ciss	+	880	_	pF	$V_{DS} = -10 V$
Output capacitance	Coss	-	325	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss		80	—	pF	f = 1 MHz
Turn-on delay time	t _{d (on)}	_	12	—	ns	$I_D = -4 A$
Rise time	tr	_	47	—	ns	$V_{GS} = -10 V$
Turn-off delay time	t _{d (off)}	-	150	—	ns	$R_L = 2 \Omega$
Fall time	t _f	_	75	—	ns	
Body to drain diode forward voltage	V _{DF}	_	-1.0	_	V	$I_F = -8 A, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}	_	170	_	ns	$I_F = -8 A, V_{GS} = 0$
						$di_F/dt = 50 A/\mu s$

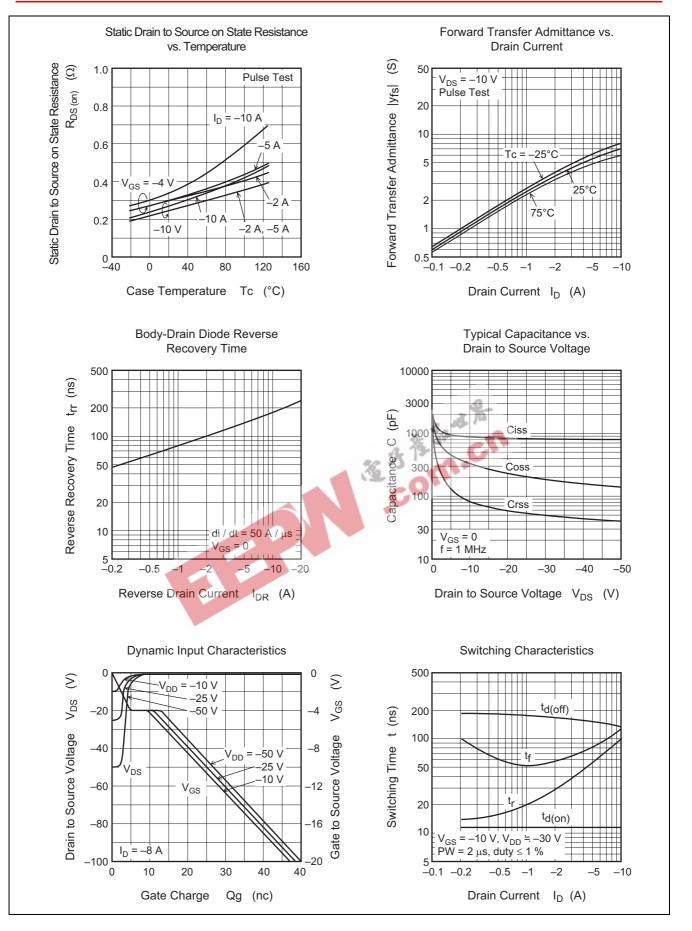
Note: 3. Pulse test



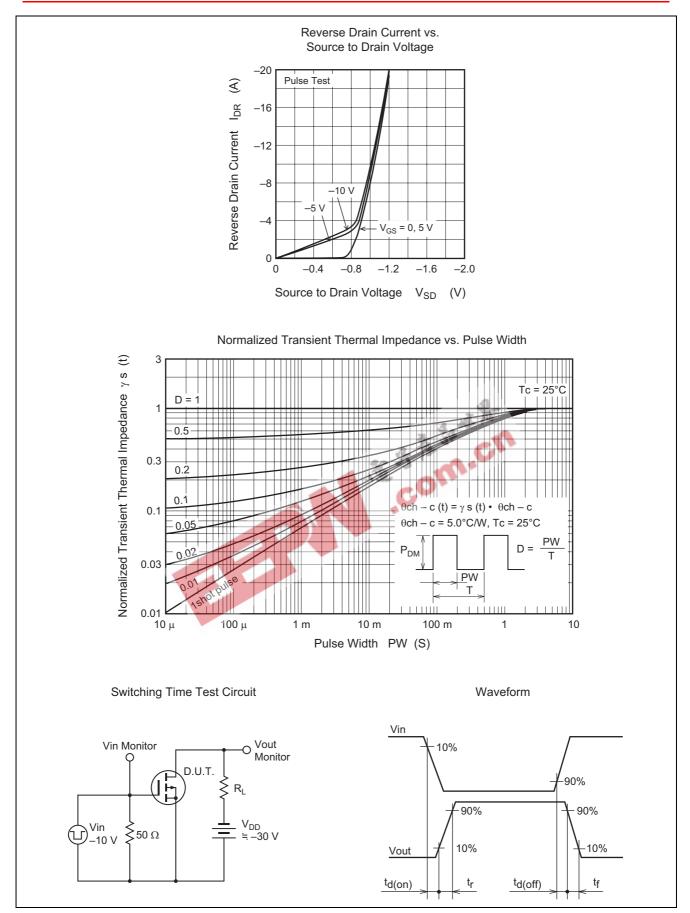
Main Characteristics





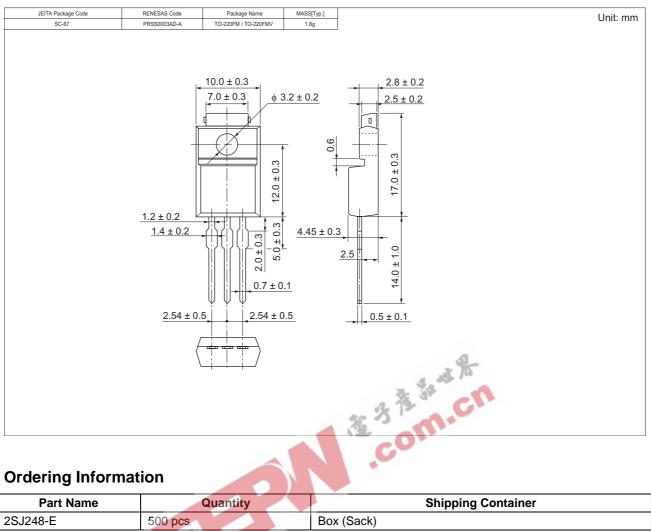








Package Dimensions



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